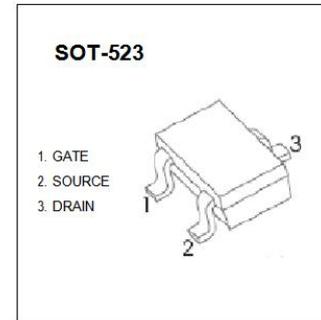
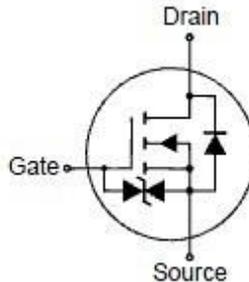


### N-Channel Enhancement Mode Field Effect Transistor

#### Features

- Low on resistance  $R_{DS(ON)}$
- Low gate threshold voltage
- Low input capacitance
- ESD protected up to 2KV

**MARKING: 72K**

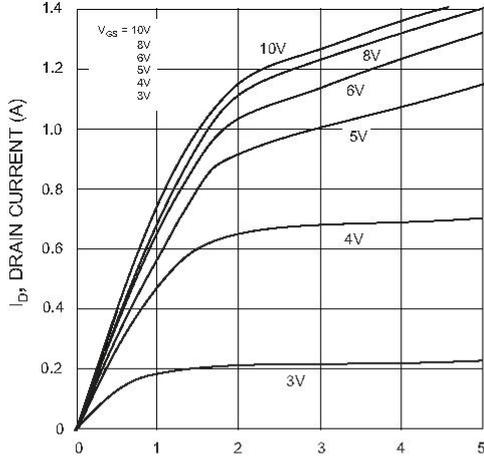


#### Absolute Maximum Ratings ( $T_a = 25\text{ }^\circ\text{C}$ )

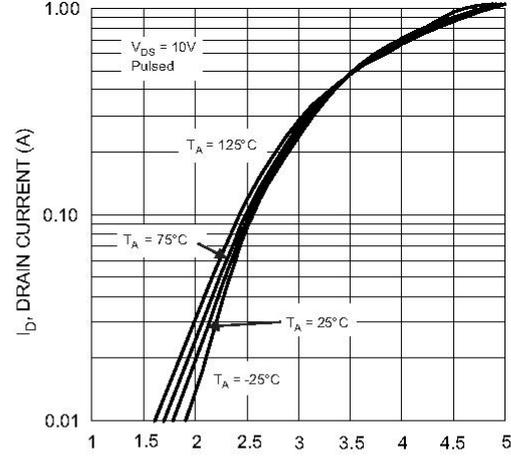
Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	60	V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$	V
Drain Current (Continuous)	$I_D$	300	mA
Drain Current (Pulse Width $\leq 10\text{ }\mu\text{s}$ )	$I_{DM}$	800	mA
Total Power Dissipation	$P_{tot}$	350	mW
Operating and Storage Temperature Range	$T_j, T_{stg}$	- 55 to + 150	$^\circ\text{C}$

#### Characteristics at $T_a = 25\text{ }^\circ\text{C}$

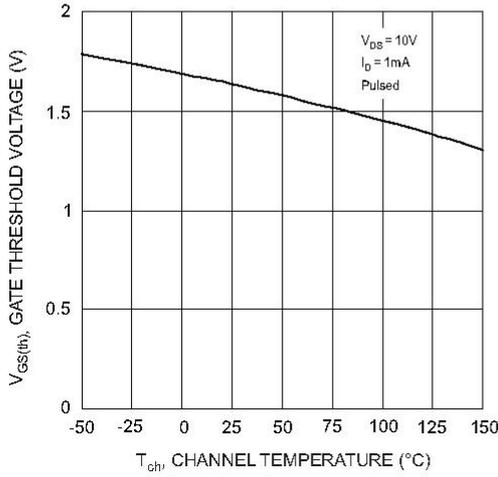
Parameter	Symbol	Min.	Max.	Unit
Drain Source Breakdown Voltage at $I_D = 10\text{ }\mu\text{A}$	$BV_{DSS}$	60	-	V
Zero Gate Voltage Drain Current at $V_{DS} = 60\text{ V}$	$I_{DSS}$	-	1	$\mu\text{A}$
Gate Source Leakage Current at $V_{GS} = \pm 20\text{ V}$	$I_{GSS}$	-	$\pm 10$	$\mu\text{A}$
Gate Threshold Voltage at $V_{DS} = 10\text{ V}, I_D = 250\text{ }\mu\text{A}$	$V_{GS(th)}$	1	2.5	V
Static Drain Source On-Resistance at $V_{GS} = 10\text{ V}, I_D = 500\text{ mA}$ at $V_{GS} = 4.5\text{ V}, I_D = 200\text{ mA}$	$R_{DS(ON)}$	- -	3 4	$\Omega$
Forward Transconductance at $V_{DS} = 10\text{ V}, I_D = 200\text{ mA}$	$g_{fs}$	80	-	mS
Input Capacitance at $V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{iss}$	-	50	pF
Output Capacitance at $V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{oss}$	-	25	pF
Reverse Transfer Capacitance at $V_{DS} = 25\text{ V}, f = 1\text{ MHz}$	$C_{rss}$	-	5	pF



$V_{GS}$ , GATE-SOURCE VOLTAGE (V)  
Fig. 1 Typical Output Characteristics



$V_{GS}$ , GATE-SOURCE VOLTAGE (V)  
Fig. 2 Typical Transfer Characteristics



$T_{ch}$ , CHANNEL TEMPERATURE ( $^{\circ}$ C)  
Fig. 3 Gate Threshold Voltage vs. Channel Temperature

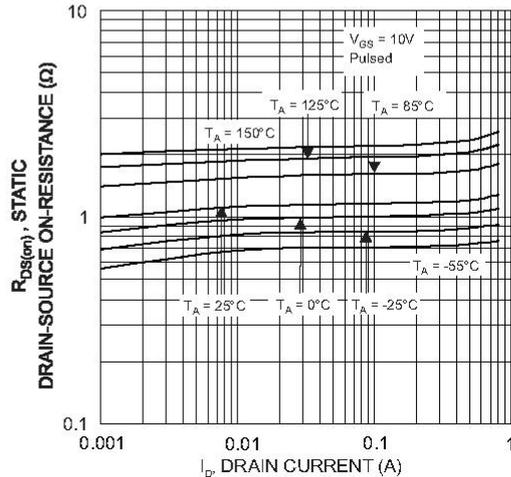
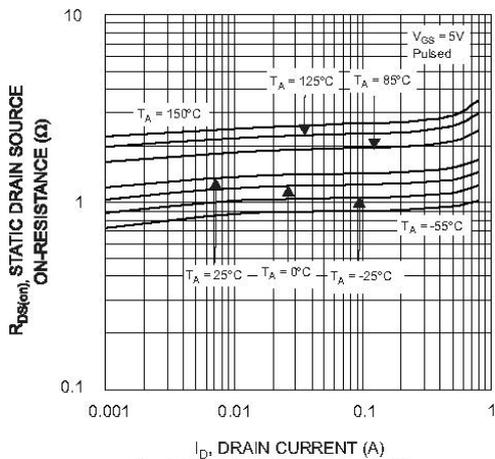
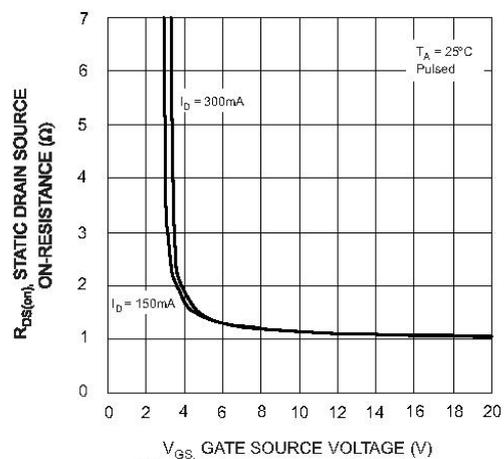


Fig. 4 Static Drain-Source On-Resistance vs. Drain Current



$I_D$ , DRAIN CURRENT (A)  
Fig. 5 Static Drain-Source On-Resistance vs. Drain Current



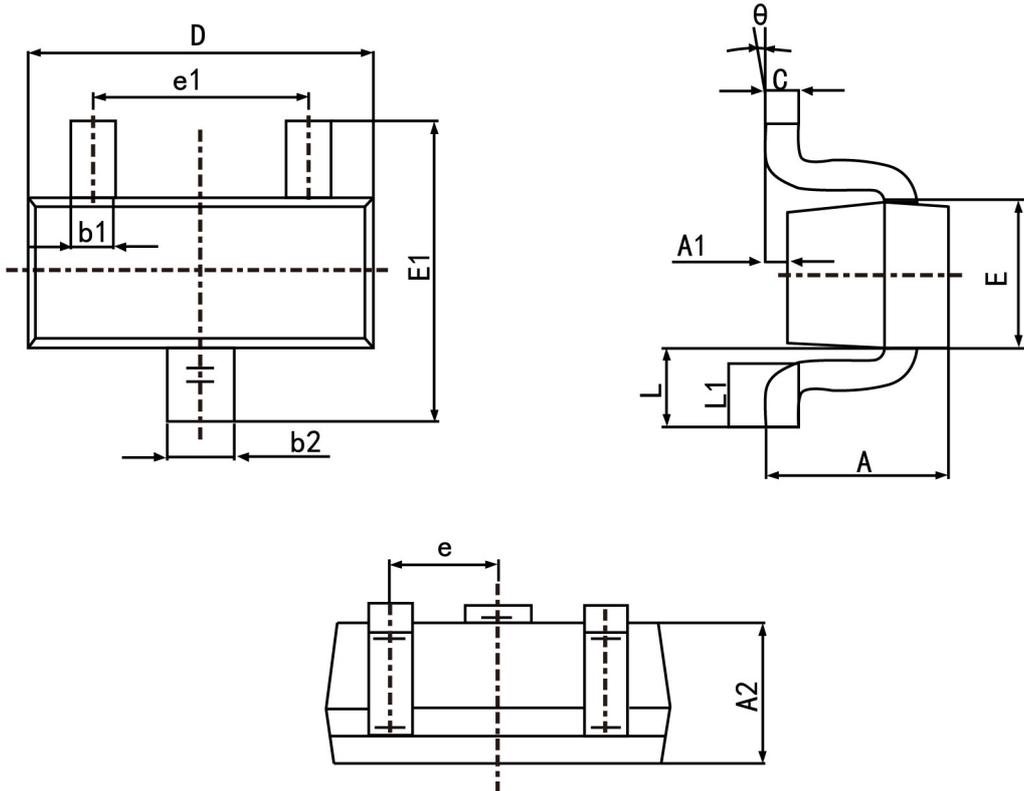
$V_{GS}$ , GATE SOURCE VOLTAGE (V)  
Fig. 6 Static Drain-Source On-Resistance vs. Gate-Source Voltage



### PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT-523



Symbol	Dimension in Millimeters	
	Min	Max
A	0.700	0.900
A1	0.000	0.100
A2	0.700	0.800
b1	0.150	0.250
b2	0.250	0.350
c	0.100	0.200
D	1.500	1.700
E	0.700	0.900
E1	1.450	1.750
e	0.500	TYP.
e1	0.900	1.100
L	0.400 REF.	
L1	0.260	0.460
θ	0°	8°